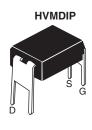


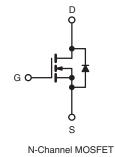
**Vishay Siliconix** 



### **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	60			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V 0.20			
Q <sub>g</sub> (Max.) (nC)	11			
Q <sub>gs</sub> (nC)	3.1			
Q <sub>gd</sub> (nC)	5.8			
Configuration	Single			





#### FEATURES

- Dynamic dV/dt Rating
- For Automatic Insertion
- End Stackable
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION				
Package	HVMDIP			
Lead (Pb)-free	IRFD014PbF			
	SiHFD014-E3			
SnPb	IRFD014			
	SiHFD014			

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub>	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	60	- V		
Gate-Source Voltage			V <sub>GS</sub>			± 20
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>A</sub> = 25 °C	1-	1.7	А	
Continuous Drain Current	VGS at 10 V	T <sub>A</sub> = 100 °C	I <sub>D</sub>	1.2		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	14	1	
Linear Derating Factor				0.0083	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	130	mJ	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C		PD	1.3	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	**		
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>	- °C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

- b.  $V_{DD}$  = 25 V, starting T<sub>J</sub> = 25 °C, L = 52 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 1.7 A (see fig. 12).
- c.  $I_{SD} \leq 10$  A,  $dI/dt \leq 90$  A/µs,  $V_{DD} \leq V_{DS}, \, T_J \leq 175$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply



Vishay Siliconix



PARAMETER	SYMBOL	TYP		MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		120		°C/W		
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 $^{\circ}$ C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL	TES		DNS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub>	= 0 V, I <sub>D</sub> = 25	50 µA	60	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	ce to 25 °C, I	<sub>D</sub> = 1 mA	-	0.063	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	50 µA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 \	/	-	-	± 100	nA
Zero Coto Voltago Drain Curront		V <sub>DS</sub>	= 60 V, V <sub>GS</sub> :	= 0 V	-	-	25	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$		-	-	250	μA	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> =	= 1.0 A <sup>b</sup>	-	-	0.20	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	= 25 V, I <sub>D</sub> = 1	1.0 A <sup>b</sup>	0.96	-	-	S
Dynamic								
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	310	-	pF	
Output Capacitance	Coss			-	160	-		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	37	-		
Total Gate Charge	Qg			-	-	11		
Gate-Source Charge	$Q_gs$	$V_{GS} = 10 V$	I <sub>D</sub> = 10 A see fia.	, V <sub>DS</sub> = 48 V 6 and 13 <sup>b</sup>	-	-	3.1	nC
Gate-Drain Charge	Q <sub>gd</sub>		see lig. 6 and 15°		-	-	5.8	1
Turn-On Delay Time	t <sub>d(on)</sub>				-	10	-	
Rise Time	t <sub>r</sub>	Voo	= 30 V lp = '	10 A	-	50	-	-
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD} = 30 \text{ V}, \text{ I}_{D} = 10 \text{ A}$ $R_{g} = 24 \Omega, \text{ R}_{D} = 2.7 \Omega, \text{ see fig. } 10^{b}$		-	13	-	ns	
Fall Time	t <sub>f</sub>		$R_g = 24 \Omega_2, R_D = 2.7 \Omega_2, \text{ see fig. 103}$		-	19	-	1
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-	nU	
Internal Source Inductance	L <sub>S</sub>			-	6.0	-	nH	
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym showing the			-	-	1.7	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	p - n junction diode		-	-	14	- A	
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	, I <sub>S</sub> = 1.7 A, V	V <sub>GS</sub> = 0 V <sup>b</sup>	-	-	1.6	V
-	-	-				<u> </u>		<u> </u>

 $T_J$  = 25 °C,  $I_F$  = 10 A, dI/dt = 100 A/ $\mu s^b$ 

Notes

t<sub>rr</sub>

Q<sub>rr</sub>

t<sub>on</sub>

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300  $\mu s;$  duty cycle  $\leq$  2 %.

Body Diode Reverse Recovery Time

Forward Turn-On Time

Body Diode Reverse Recovery Charge

70

0.20

\_

\_

Intrinsic turn-on time is negligible (turn-on is dominated by  $L_S$  and  $L_D$ )

140

0.40

ns

μC





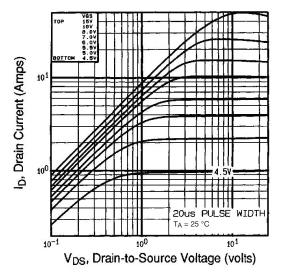


Fig. 1 - Typical Output Characteristics, T<sub>A</sub> = 25 °C

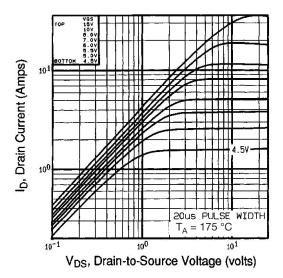


Fig. 2 - Typical Output Characteristics,  $T_A = 175 \ ^\circ C$ 

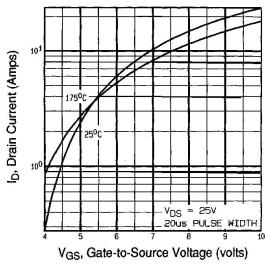


Fig. 3 - Typical Transfer Characteristics

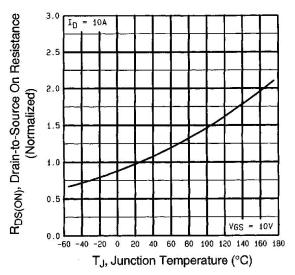


Fig. 4 - Normalized On-Resistance vs. Temperature



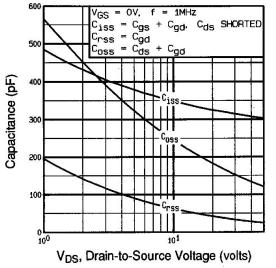
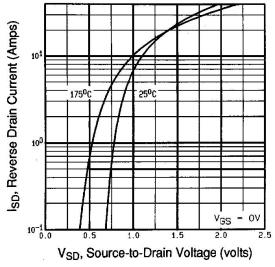


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





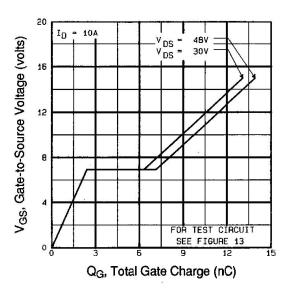
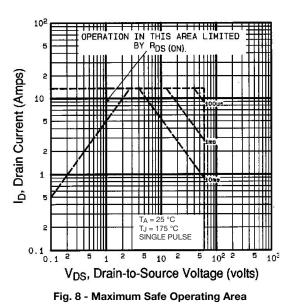


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage





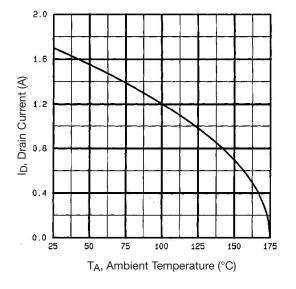


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

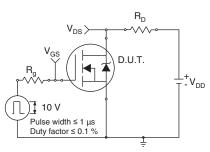


Fig. 10a - Switching Time Test Circuit

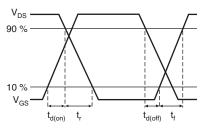


Fig. 10b - Switching Time Waveforms

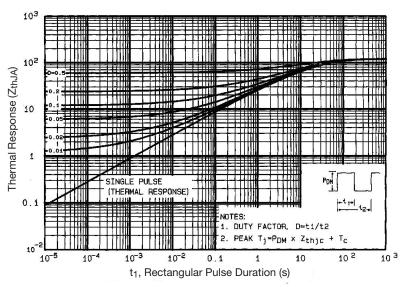


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



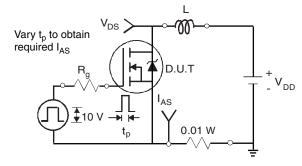


Fig. 12a - Unclamped Inductive Test Circuit

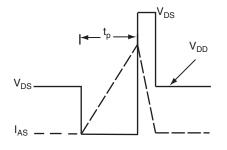


Fig. 12b - Unclamped Inductive Waveforms

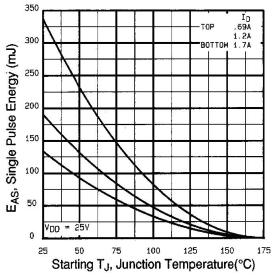
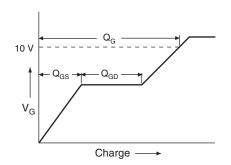


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





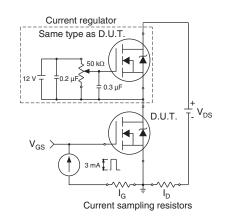
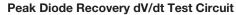
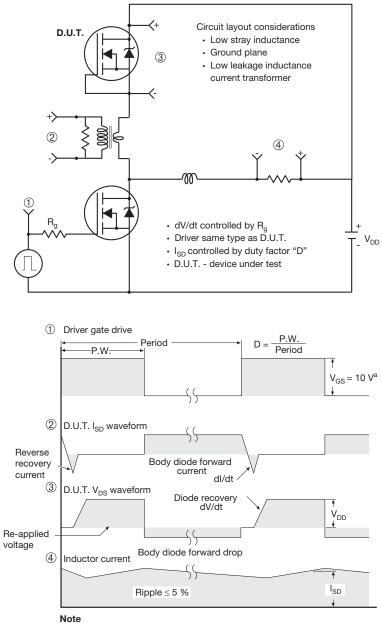


Fig. 13b - Gate Charge Test Circuit



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a.  $V_{GS} = 5 V$  for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?91128">www.vishay.com/ppg?91128</a>.



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#### HVM DIP (High voltage)





	INCHES		MILLIN	IETERS
DIM.	MIN.	MAX.	MIN.	MAX.
А	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36
ECN: X10-0386-Rev. B, 0 DWG: 5974	06-Sep-10			

Note

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.



Vishay

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